TE Internal #: 5380635-2

Pin Sockets, Socket Length .254 in [6.45 mm], Hole Size (Recommended) 2.26 mm [.089 in], None, Open Bottom, 25 –

19AWG Wire Size

View on TE.com >



### Connectors > Socket Connectors > Pin Sockets











Socket Length: 6.45 mm [.254 in]

Hole Size (Recommended): 2.26 mm [ .089 in ]

Solder Process Feature: None
Socket Sleeve Style: Open Bottom

Contact Spring Plating Thickness

Contact Base Material

Wire Size: 25 – 19 AWG

### **Features**

## Product Type Features

Socket Sleeve Style	Open Bottom
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Wire/Cable Type	Discrete Wire
Profile	Zero
Product Type	Contact
Body Features	
Sleeve Material	Copper
Sleeve Plating Material	Tin
Contact Features	
Contact Spring Plating Material	Gold

.762 μm[30 μin]

Beryllium Copper



Contact Current Rating (Max)	7.5 A
Socket Type	Discrete
Contact Transmits (Typical)	Signal (Data)/Power
Contact Mating Area Plating Thickness	30 μm[30 μin]
Contact Type	Socket
Termination Features	
Insertion Method	Hand/Semi-Automatic
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Termination Method to Wire & Cable	Solder
Dimensions	
Socket Length	6.45 mm[.254 in]
Hole Size (Recommended)	2.26 mm[.089 in]
Wire Size	.162 – .653 mm²
Mating Pin Diameter Range	.46 – 1.02 mm[.018 – .04 in]
PCB Thickness (Recommended)	.79 – 3.18 mm[.031 – .125 in]
Usage Conditions	
Operating Temperature Range	-65 – 126 °C[-85 – 258 °F]
Operation/Application	
Solder Process Feature	None
Circuit Application	Power & Signal
Packaging Features	
Packaging Quantity	2000
Packaging Method	Bag, Loose Piece
Other	

# **Product Compliance**

Spring Material

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	

Beryllium Copper



Current ECHA Candidate List: JAN 2021

(211)

Candidate List Declared Against: JAN 2021

(211)

Does not contain REACH SVHC

Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC

Free

Solder Process Capability Pin-in-Paste capable to 260°C

#### Product Compliance Disclaimer

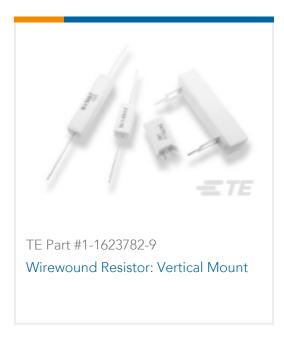
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**





# Customers Also Bought

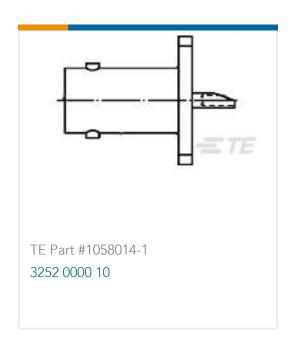






















### **Documents**

### **Product Drawings**

RCR AU-SPR SN-CUP OE 018-040

English

### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5380635-2\_O.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5380635-2\_O.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5380635-2\_O.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

## **Product Specifications**

Application Specification

English

Reusable Receptacles For Component Testing

English